#### HEX SCHMITT-TRIGGER INVERTERS SDLS049B - DECEMBER 1983 - REVISED FEBRUARY 2002

- Operation From Very Slow Edges
- Improved Line-Receiving Characteristics
- High Noise Immunity

#### description

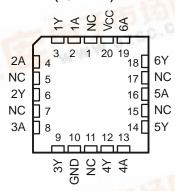
Each circuit functions as an inverter, but because of the Schmitt action, it has different input threshold levels for positive-going  $(V_{T+})$  and negative-going  $(V_{T-})$  signals.

These circuits are temperature compensated and can be triggered from the slowest of input ramps and still give clean, jitter-free output signals.

SN5414, SN54LS14 . . . J OR W PACKAGE SN7414 . . . D, N, OR NS PACKAGE SN74LS14 . . . D, DB, OR N PACKAGE (TOP VIEW)



SN54LS14 . . . FK PACKAGE (TOP VIEW)



NC – No internal connection

#### **ORDERING INFORMATION**

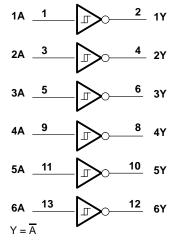
	4.00			
$T_A$	PAC	KAGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	DDID N	Tube	SN7414N	SN7414N
	PDIP – N	Tube	SN74LS14N	SN74LS14N
	0750	Tube	SN7414D	7444
0°C to 70°C	SOIC - D	Tape and reel	SN7414DR	7414
0°C to 70°C	SOIC = D	Tube	SN74LS14D	1.044
		Tape and reel	SN74LS14DR	LS14
	SOP – NS	Tape and reel	SN7414NSR	SN7414
	SSOP - DB	Tape and reel	SN74LS14DBR	LS14
		Tube	SN5414J	SN5414J
	CDIP – J	Tube	SNJ5414J	SNJ5414J
	CDIP = J	Tube	SN54LS14J	SN54LS14J
–55°C to 125°C	7751	Tube	SNJ54LS14J	SNJ54LS14J
	CFP – W	Tube	SNJ5414W	SNJ5414W
	CFP - W	Tube	SNJ54LS14W	SNJ54LS14W
	LCCC – FK	Tube	SNJ54LS14FK	SNJ54LS14FK

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

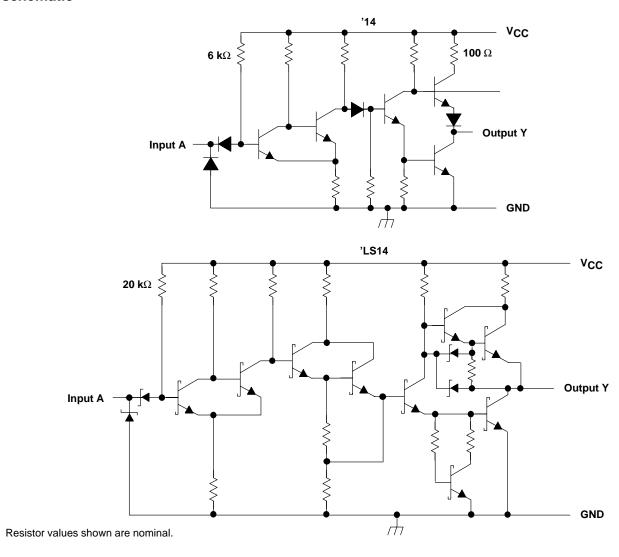


#### logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, NS, and W packages.

#### schematic



#### absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)		
Input voltage: '14		 5.5 V
'LS14		 7 V
Package thermal impedance, θ <sub>JA</sub> (see Note 2)	):D package .	 86°C/W
•	DB package	 96°C/W
	N package .	 80°C/W
	NS package	 
Storage temperaturerange, T <sub>sta</sub>		 –65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

			SN5414		,	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
ЮН	High-level output current			-0.8			-0.8	mA
loL	Low-level output current			16			16	mA
TA	Operating free-air temperature	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			SN5414 SN7414		UNIT		
		TEST COND		MIN	TYP§	MAX	
V <sub>T+</sub>	V <sub>CC</sub> = 5 V			1.5	1.7	2	V
V <sub>T</sub> _	V <sub>CC</sub> = 5 V			0.6	0.9	1.1	V
Hysteresis (V <sub>T+</sub> – V <sub>T</sub> –)	V <sub>CC</sub> = 5 V			0.4	0.8		V
VIK	$V_{CC} = MIN,$	I <sub>I</sub> = -12 mA				-1.5	V
VOH	$V_{CC} = MIN,$	$V_{I} = 0.6 V$ ,	$I_{OH} = -0.8 \text{ mA}$	2.4	3.4		V
V <sub>OL</sub>	$V_{CC} = MIN,$	$V_I = 2 V$ ,	I <sub>OL</sub> = 16 mA		0.2	0.4	V
I <sub>T+</sub>	$V_{CC} = 5 V$ ,	$V_I = V_{T+}$			-0.43		mA
I <sub>T</sub> _	$V_{CC} = 5 V$ ,	$V_I = V_{T-}$			-0.56		mA
IĮ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 5.5 V				1	mA
lіН	$V_{CC} = MAX$ ,	$V_{IH} = 2.4 V$				40	μΑ
I <sub>IL</sub>	$V_{CC} = MAX$ ,	$V_{IL} = 0.4 V$			-0.8	-1.2	mA
IOS¶	$V_{CC} = MAX$			-18		-55	mA
<sup>I</sup> ССН	V <sub>CC</sub> = MAX				22	36	mA
ICCL	V <sub>CC</sub> = MAX				39	60	mA

<sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



NOTES: 1. Voltage values are with respect to network ground terminal.

<sup>2.</sup> The package termal impedance is calculated in accordance with JESD 51-7

<sup>§</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

 $<sup>\</sup>P$  Not more than one output should be shorted at a time.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			SN5414 SN7414		UNIT
	(INFOT)	(001701)			MIN	TYP	MAX	
<sup>t</sup> PLH	Δ	V	R <sub>L</sub> = 400 Ω,	C <sub>I</sub> = 15 pF		15	22	ns
t <sub>PHL</sub>	<b>1</b> ^	,	11 = 700 22,	OL = 10 pi		15	22	113

#### recommended operating conditions

		S	N54LS14	4	S	N74LS14	4	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
loн	High-level output current			-0.4			-0.4	mA
lOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	-55		125	0		70	°C

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		TEST CONDITIONS†			N54LS1	4	S	N74LS14	4	UNIT
PARAMETER	TEST CONDITIONS:			MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	UNII
V <sub>T+</sub>	V <sub>CC</sub> = 5 V			1.4	1.6	1.9	1.4	1.6	1.9	V
V <sub>T</sub> _	V <sub>CC</sub> = 5 V			0.5	0.8	1	0.5	0.8	1	V
Hysteresis (V <sub>T+</sub> – V <sub>T</sub> –)	V <sub>CC</sub> = 5 V			0.4	0.8		0.4	0.8		٧
VIK	$V_{CC} = MIN,$	$I_{I} = -18 \text{ mA}$				-1.5			-1.5	V
Voн	$V_{CC} = MIN,$	$V_{I} = 0.5 V$ ,	$I_{OH} = -0.4 \text{ mA}$	2.5	3.4		2.7	3.4		V
Voi	V <sub>CC</sub> = MIN,	V <sub>I</sub> = -1.9 V	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	V
VOL	ACC = IMIIA'	V  = -1.9 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	V
I <sub>T+</sub>	$V_{CC} = 5 V$ ,	$V_I = V_{T+}$			-0.14			-0.14		mA
I <sub>T</sub> _	$V_{CC} = 5 V$ ,	$V_I = V_{T-}$			-0.18			-0.18		mA
lį	$V_{CC} = MAX$ ,	V <sub>I</sub> = 7 V				0.1			0.1	mA
IH	$V_{CC} = MAX$ ,	V <sub>IH</sub> = 2.7 V				20			20	μΑ
I <sub>I</sub> L	$V_{CC} = MAX$ ,	V <sub>IL</sub> = 0.4 V				-0.4			-0.4	mA
I <sub>OS</sub> §	$V_{CC} = MAX$			-20		-100	-20		-100	mA
Іссн	$V_{CC} = MAX$				8.6	16		8.6	16	mA
ICCL	V <sub>CC</sub> = MAX				12	21		12	21	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

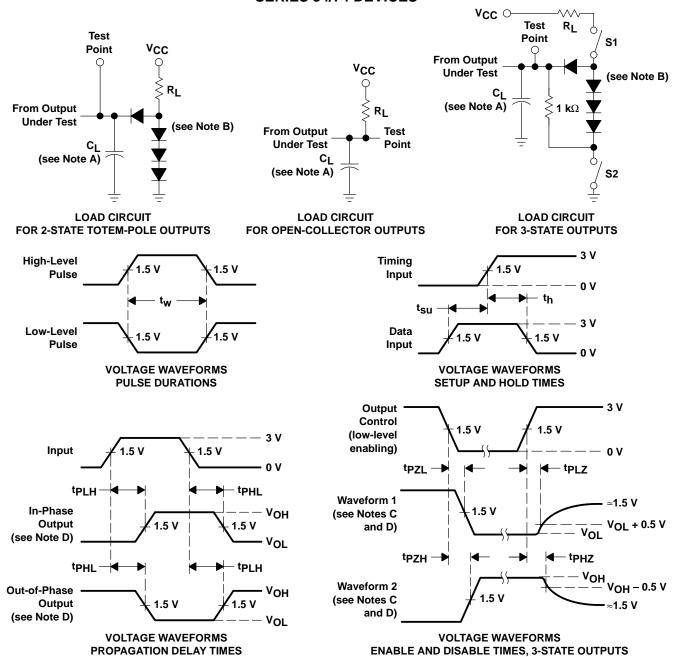
## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	Δ	V	$R_1 = 2 k\Omega$ , $C_1 = 15 pF$		15	22	ns
tPHL	^	1	N 2 1/22,		15	22	113



<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. § Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

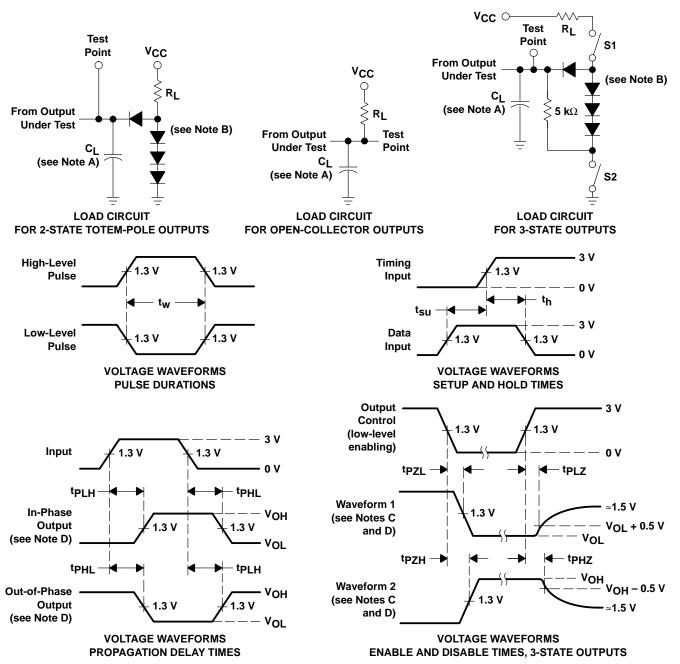
## PARAMETER MEASUREMENT INFORMATION SERIES 54/74 DEVICES



- NOTES: A.  $C_L$  includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50 \Omega$ ;  $t_r$  and  $t_f \leq$  7 ns for Series 54/74 devices and  $t_r$  and  $t_f \leq$  2.5 ns for Series 54S/74S devices.
  - F. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES



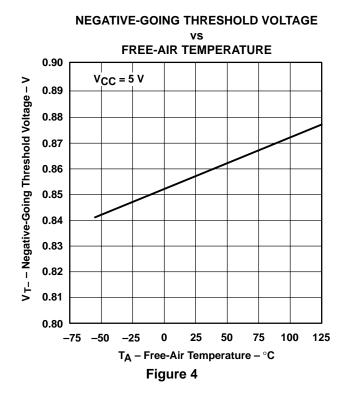
- NOTES: A. C<sub>L</sub> includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
  - F. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50~\Omega$ ,  $t_f \leq$  1.5 ns,  $t_f \leq$  2.6 ns.
  - G. The outputs are measured one at a time with one input transition per measurement.

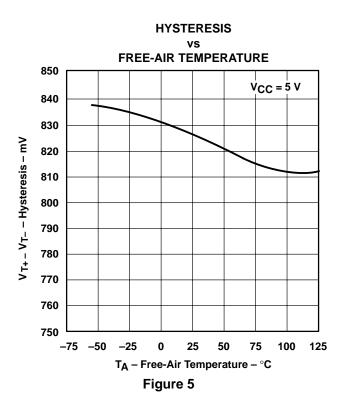
Figure 2. Load Circuits and Voltage Waveforms



#### TYPICAL CHARACTERISTICS OF '14 CIRCUITS'

#### POSITIVE-GOING THRESHOLD VOLTAGE FREE-AIR TEMPERATURE 1.70 **VCC = 5 V** V<sub>T+</sub> – Positive-Going Threshold Voltage – V 1.69 1.68 1.67 1.66 1.65 1.64 1.63 1.62 1.61 1.60 25 50 -50 -25 0 75 100 -75 125 T<sub>A</sub> - Free-Air Temperature - °C Figure 3

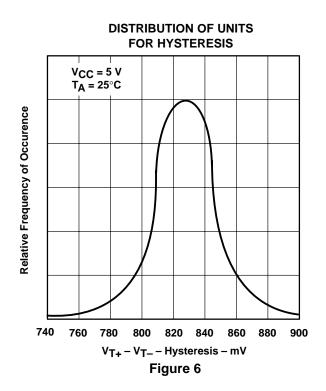


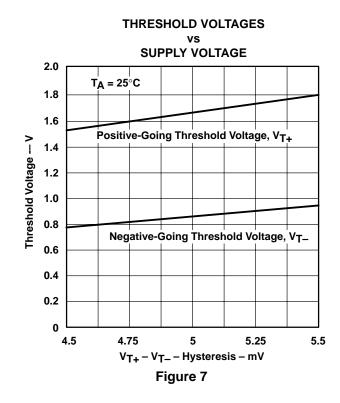


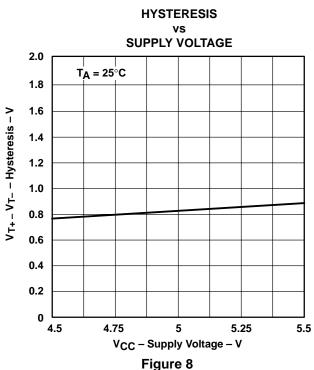
<sup>†</sup> Data for temperatures below 0°C and above 70°C and supply voltage below 4.75 V and above 5.25 V are applicable for SN5414 only.

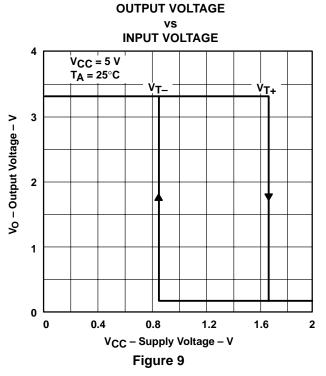


#### TYPICAL CHARACTERISTICS OF '14 CIRCUITS'





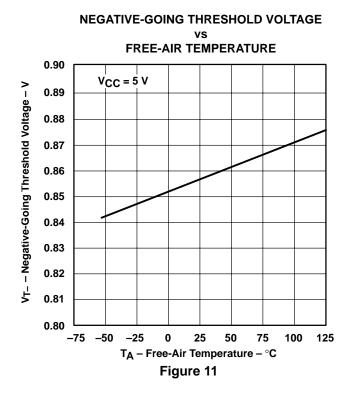


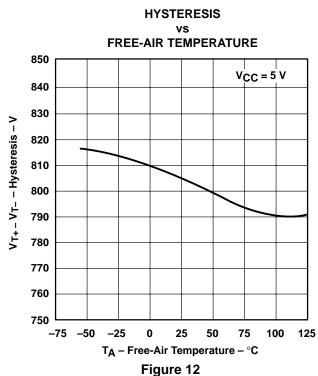


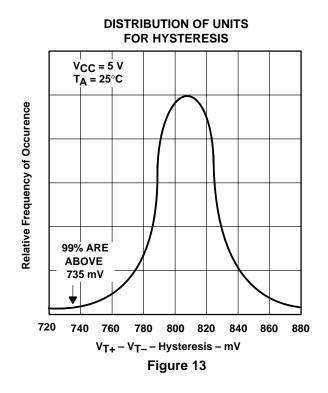
<sup>†</sup> Data for temperatures below 0°C and above 70°C and supply voltage below 4.75 V and above 5.25 V are applicable for SN5414 only.

#### TYPICAL CHARACTERISTICS OF 'LS14 CIRCUITS'

#### POSITIVE-GOING THRESHOLD VOLTAGE FREE-AIR TEMPERATURE 1.70 $V_{CC} = 5 V$ Positive-Going Threshold Voltage - V 1.69 1.68 1.67 1.66 1.65 1.64 1.63 1.62 1.61 1.60 -25 25 50 75 100 125 -75 -50 T<sub>A</sub> - Free-Air Temperature - °C Figure 10



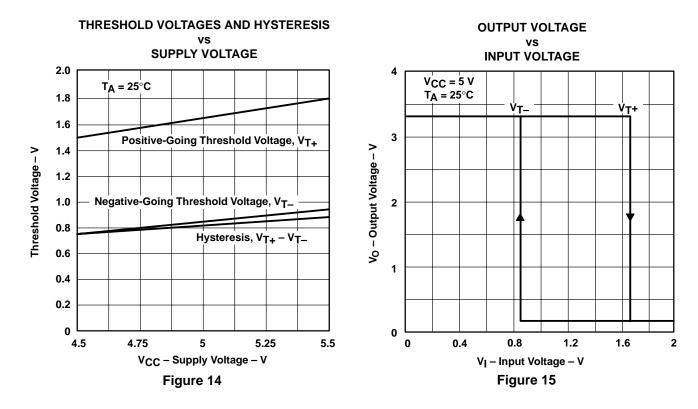




<sup>†</sup> Data for temperatures below 0°C and above 70°C and supply voltage below 4.75 V and above 5.25 V are applicable for SN5414 only.



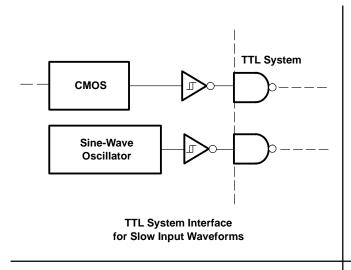
#### TYPICAL CHARACTERISTICS OF 'LS14 CIRCUITS'

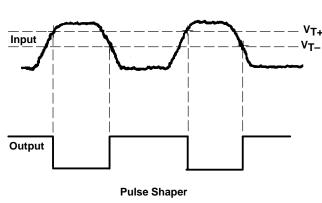


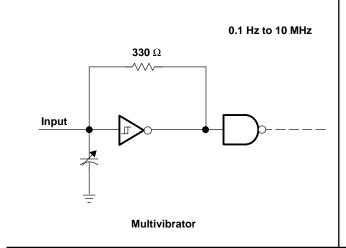
<sup>†</sup> Data for temperatures below 0°C and above 70°C and supply voltage below 4.75 V and above 5.25 V are applicable for SN5414 only.

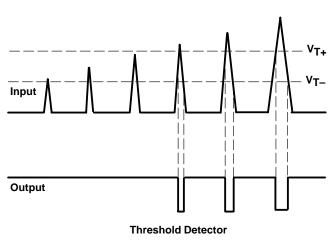


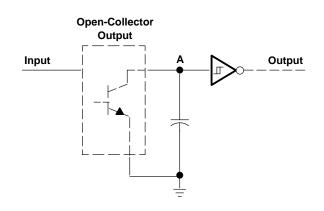
#### TYPICAL APPLICATION DATA

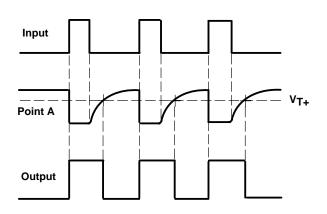












**Pulse Stretcher** 







3-Jun-2005

#### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9665801Q2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9665801QCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
5962-9665801QDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
5962-9665801VCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
5962-9665801VDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
JM38510/31302BCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN5414J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN54LS14J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SN7414D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN7414DE4	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN7414DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN7414DRE4	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN7414N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN7414N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN7414NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN7414NSRE4	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS14D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS14DBR	ACTIVE	SSOP	DB	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS14DBRE4	ACTIVE	SSOP	DB	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS14DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS14N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS14N3	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74LS14NE4	ACTIVE	PDIP	N	14	25	TBD	Call TI	Call TI
SN74LS14NSRG4	ACTIVE	so	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ5414J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ5414W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS14FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS14J	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS14W	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.



#### PACKAGE OPTION ADDENDUM

3-Jun-2005

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

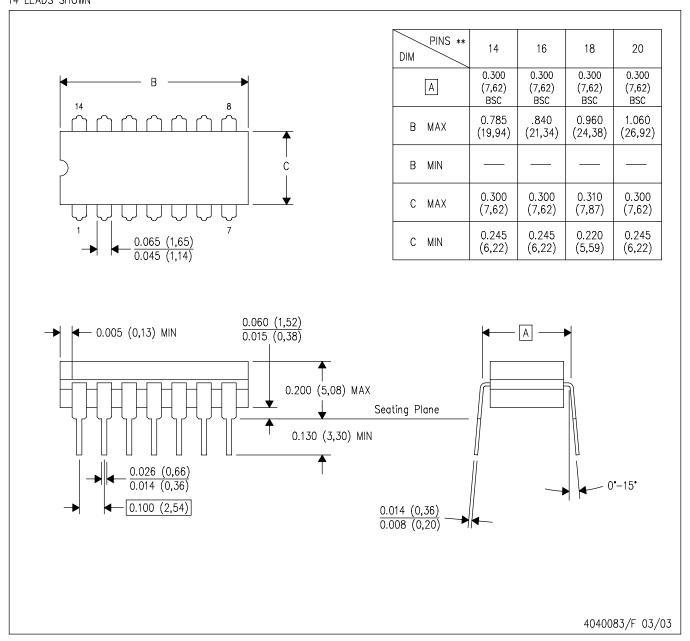
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

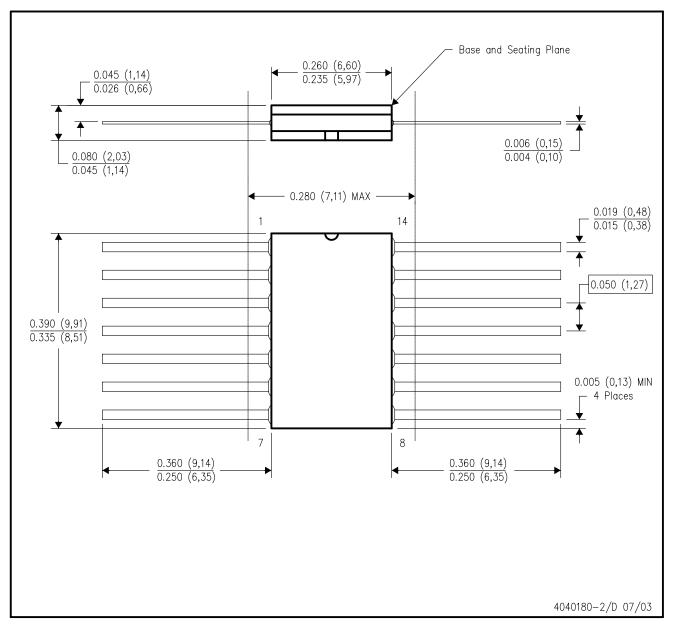
## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



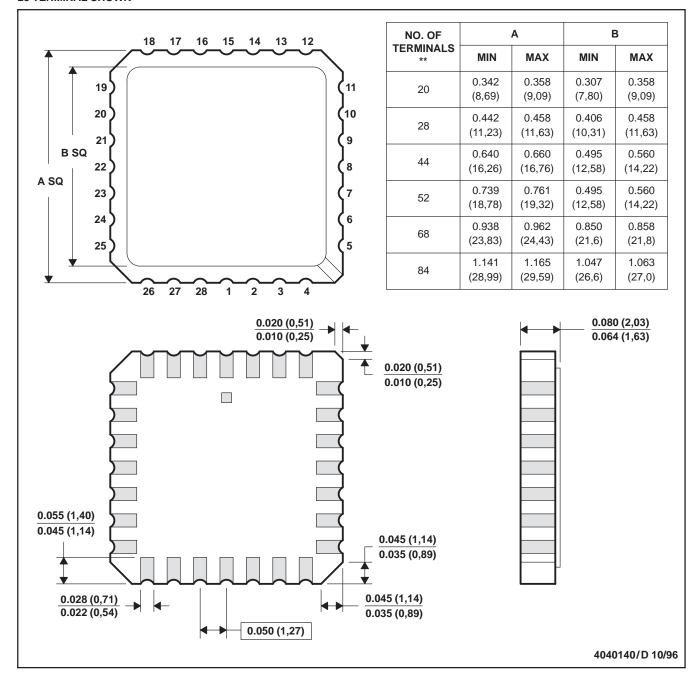
- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



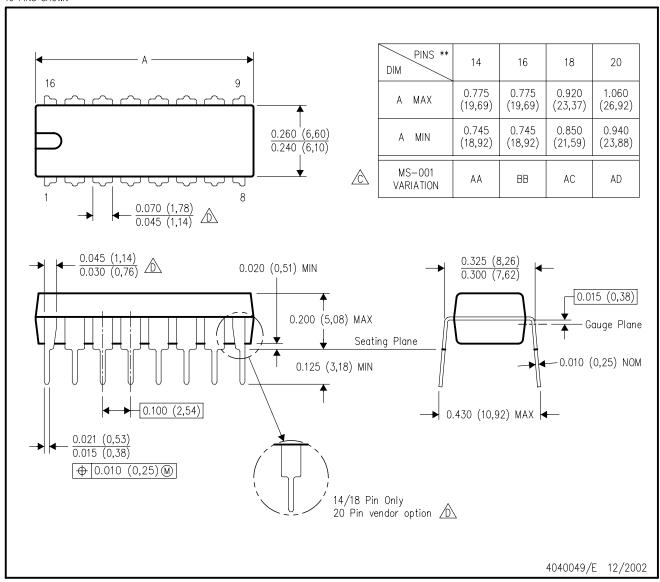
- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

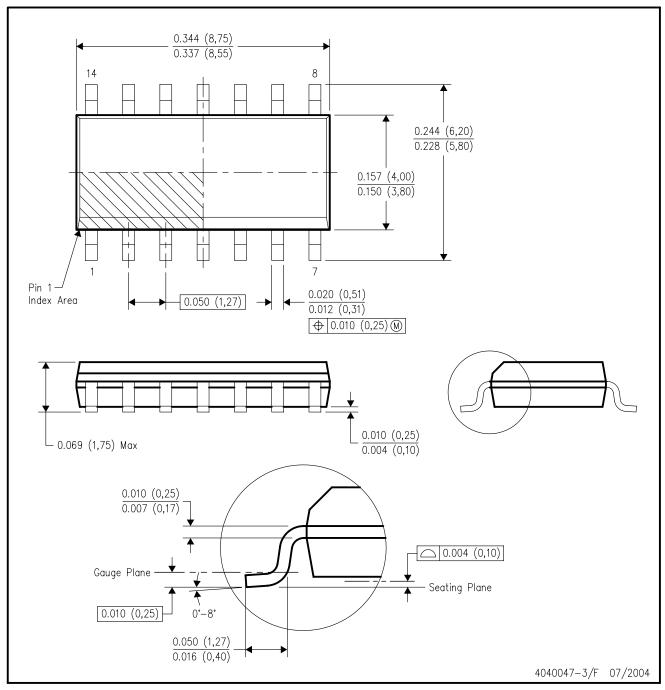
16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

## D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.

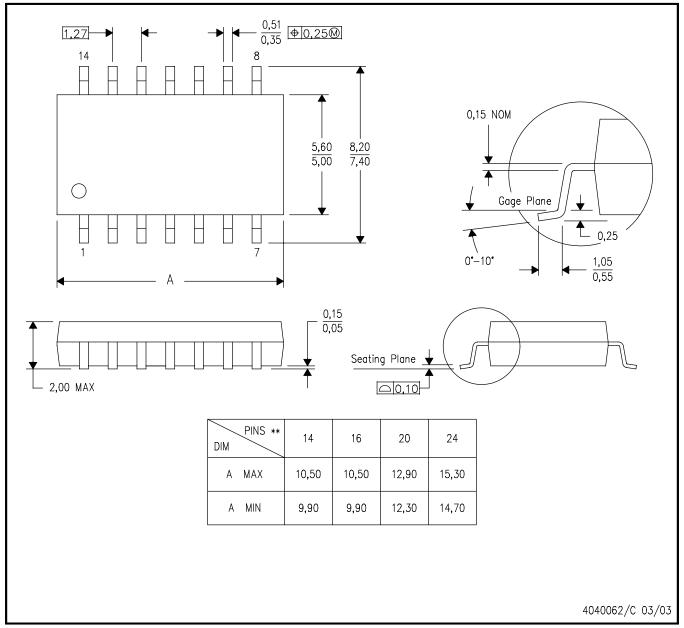


#### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

#### 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



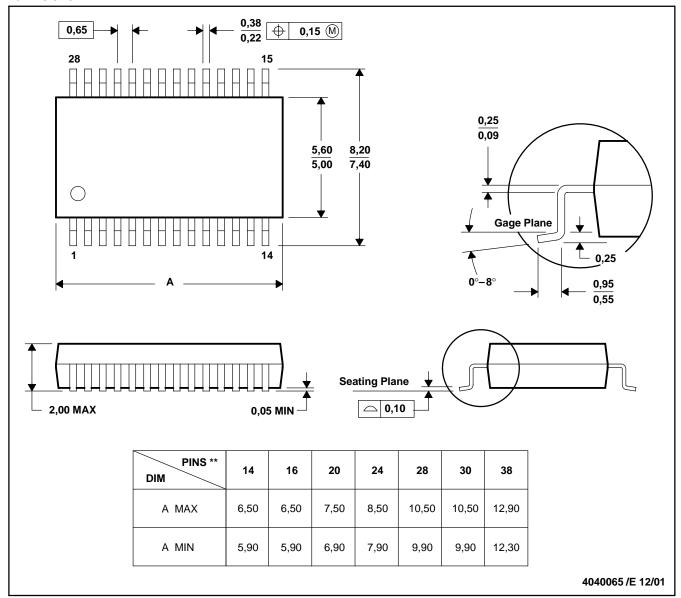
- . All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### DB (R-PDSO-G\*\*)

#### **PLASTIC SMALL-OUTLINE**

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



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